ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® International a	Composition De 2005. IPC, Bannockt nd Pan-American co	claration ourn, Illinois. A opyright conver	Il rights reserved untions.	nder both	This docume level parts, th	ent is a declaration he declaration en	on of the substan	ces within the ma wer level materi	anufacturer li als for which	sted item. Note: if the manufacturer	the item is an a has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				is Materials a	ials and Mfg Information			
upplier Information													
ompany name*	Company unique ID			l	Unique ID Authority				Response Date*				
nsemi									2024-04-25				
Contact Name Title			Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone - Representative*			En	Email - Representative*			
roduct-Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	fr Item Number Mfr Item Name			Effectiv		Version	Manufacturing Site		Weight*	UOM	Unit Type	
	MJ11032G BIP T03 NPN		BIP T03 NPN 504	50A 120V FG		2024-04-25		MX5		13309.014	mg	Each	
Ianufacturing Proccess Info	ormation						-				•		
Terminal Plating / Grid Ar	Terminal Plating / Grid Array Material Termin		nal Base Alloy J-STD-020 MSL		Rating	Peak Process Body Temperature Max Tir		ature Max Time	e at Peak Ten	nperature Numbe	er of Reflow Cy	cles	
SnAgCu (CU Alloy NA			0 C		30		seconds 3				
omments													
or more information regarding ma	terial composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chro	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			Ince category (JIG or Requester) or [F] Optionally enter the positive (+)				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	40.0	mg	Supplier	Silicon (Si)	7440-21-3		40	mg
Die Attach	2091.12	mg	Supplier	Indium (In)	7440-74-6		104.556	mg
			Supplier	Silver (Ag)	7440-22-4		62.7336	mg
			А	Lead (Pb)	7439-92-1	7a	1923.8306	mg
Lead Frame	11138.1	mg	В	Nickel (Ni)	7440-02-0		111.381	mg
			Supplier	Iron (Fe)	7439-89-6		11026.7188	mg
Plating	38.83	mg	Supplier	Silver (Ag)	7440-22-4		1.1649	mg
			Supplier	Tin (Sn)	7440-31-5		37.471	mg
			Supplier	Copper (Cu)	7440-50-8		0.1942	mg
Wire Bond - Al	0.964	mg	Supplier	Aluminum (Al)	7429-90-5		0.964	mg